

Technical Data Sheet

EVSE10 is a soft one-component silicone-based thermally conductive gap-filling material with high thermal conductivity, low interfacial thermal resistance and good thixotropy. It is an ideal material for applications with large gap tolerances. It is filled between the electronic components to be cooled and the heat sink/housing, etc., making them in close contact, reducing the thermal resistance, and quickly and effectively reducing the temperature of the electronic components, thereby extending the life of the electronic components and improving their reliability. The EVSE10 can be applied by hand or b automated dispensing equipment.



Applications

- ✓ Hard disk, mobile phone
- ♥ Optical precision equipment
- √ Laptop
- Mobile and communication equipment
- Automobile engine control equipment
- High-end industrial control and medical electronics



EVSE10

Test Results	Test Methods
Pink	Visual
35g/min	**
2.0g/cm3	Helium true density method
250000	ASTM D2196
>1013Ωcm	ASTM D257
1.0W/mK	ASTM D5470
>200 VAC/mil	ASTM D149
5.5	ASTM D150
0.09mm	**
-50~200	**
12month	**
175ppm/K	ASTM E831
V-0	UL 94
PASS	IEC 62321
PASS	EN14582
PASS	EN14372
	Pink 35g/min 2.0g/cm3 250000 >1013Ωcm 1.0W/mK >200 VAC/mil 5.5 0.09mm -50~200 12month 175ppm/K V-0 PASS PASS

Our products have passed 1000 hours cold and hot shock test,1000 hours double 85 test,1000 hours high temperature aging test. CRT is committed to providing the most reliable heat conduction solutions for automobile, communication, security and other industries.

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Note: The information provided herein is accurate at time of publication. It is the responsibility of the end-user to confirm compliance to their application. All test data is typical. Therefore, these recommendations and data are for reference only and not as a product warranty.